

# TXDVxx12

## 12 A high voltage Triacs

## Features

- On-state current (I<sub>T(RMS)</sub>): 12 A
- Max. blocking voltage (V<sub>DRM</sub>/V<sub>RRM</sub>): 1200 V
- Gate current (I<sub>GT</sub>): 100 mA
- Commutation @ 10 V/µs: up to 42.5 A/ms
- Noise immunity: 2 kV/µs
- Insulated package:
  - 2,500 V rms (UL recognized: E81734).

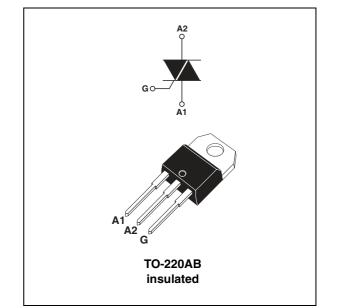
## Description

The TXDVxx12 series uses a high performance alternistor technology.

Featuring very high commutation levels and high surge current capability, these devices are well adapted to power control for inductive and resistive loads (motor, transformer...) especially on three-phase power grid. Targeted three-phase applications include heating systems, motor starters, and induction motor speed control (especially for fans).

#### Table 1. Device summary

Parameter	TXDV812RG TXDV1212RG			
Blocking voltage V <sub>DRM</sub> /V <sub>RRM</sub>	800 V	1200 V		
On-state current I <sub>T(RMS)</sub>	12 A			
Gate current IGT	100 mA			



# 1 Characteristics

Symbol	Parameter	Value	Unit			
I <sub>T(RMS)</sub>	On-state rms current (180° conduction angle) $T_c = 90$ °C			12	Α	
V <sub>DRM</sub>	Repetitive peak off-state voltage	TXDV812	T - 125 °C	800	V	
V <sub>RRM</sub>	nepetitive peak off-state voltage	TXDV1212	— T <sub>j</sub> = 125 °C	1200		
				170		
I <sub>TSM</sub>	Non repetitive surge peak on-state current	t <sub>p</sub> = 8.3 ms	T <sub>j</sub> = 25 °C	125	А	
		t <sub>p</sub> = 10 ms		120		
l <sup>2</sup> t	I <sup>2</sup> t value for fusing	t <sub>p</sub> = 10 ms	ł	72	A <sup>2</sup> s	
dl/dt	Critical rate of rise of on-state current $I_G = 500 \text{ mA}$ $dI_G/dt = 1 \text{ A/}\mu\text{s}$	E = 50 Hz		100	A/µs	
T <sub>stg</sub> T <sub>j</sub>	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C	
V <sub>INS(RMS)</sub> <sup>(1)</sup>	Insulation rms voltage			2500	V	

#### Table 2. Absolute maximum ratings (limiting values)

1. A1, A2, gate terminals to case for 1 minute

### Table 3. Electrical characteristics ( $T_j = 25 \text{ °C}$ , unless otherwise specified)

Symbol	Test conditions	Quadrant	Quadrant		Value			
Symbol	Test conditions	Quadrant		TXDV812	TXDV1212			
I <sub>GT</sub>	V <sub>D</sub> = 12 V DC, R <sub>I</sub> = 33 Ω	1-11-111	MAX.	1(	00	mA		
V <sub>GT</sub>	$v_{\rm D} = 12 \ v \ {\rm DO}, \ {\rm n_{\rm L}} = 33 \ {\rm sz}$	1-11-111	MAX.	1	.5	V		
V <sub>GD</sub>	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ $T_j = 110^{\circ}$	C I-II-III	MIN.	0	.2	V		
t <sub>gt</sub>	$V_D = V_{DRM}$ I <sub>G</sub> = 500 mA dI <sub>G</sub> /dt = 3 A/µs	1-11-111	TYP.	2	.5	μs		
I.	$I_{G} = 1.2 \text{ x } I_{GT}$	1-111	TYP.	100		mA		
ΙL	IG - 1.2 × IGT	II	.		200			
I <sub>H</sub> <sup>(1)</sup>	I <sub>T</sub> = 500 mA Gate open		MAX.	100		mA		
dV/dt <sup>(1)</sup>	Linear slope up to: $V_D = 67\% V_{DRM}$ Gate open $T_j = 125 \text{ °C}$		MIN.	2	2	kV/µs		
(dl/dt)c <sup>(1)</sup>	$(dV/dt)c = 10 V/\mu s$ $T_j = 110 °$	С	MIN.	42.5	30	A/ms		
V <sub>TM</sub> <sup>(1)</sup>	I <sub>TM</sub> = 17 A t <sub>p</sub> = 380 μs		MAX.	1.	95	V		
V <sub>to</sub> <sup>(1)</sup>	Threshold voltage		MAX.	MAX. 1.21		V		
R <sub>d</sub> <sup>(1)</sup>	Dynamic resistance		MAX.	4	0	mΩ		
I <sub>DRM</sub>	$V_{DBM} = V_{RBM}$ $T_j = 25 °C$		MAX		MAX. 0.01		01	mA
I <sub>RRM</sub>	$v_{\text{DRM}} = v_{\text{RRM}}$ $T_j = 110^{\circ}$	С	WI/1/1.	2	5			

1. For either polarity of electrode  $\mathsf{A}_2$  voltage with reference to electrode  $\mathsf{A}_1.$ 



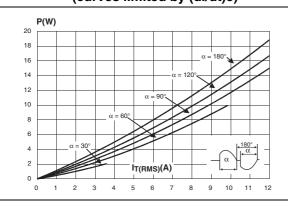
Symbol	Parameter	Value	Unit	
P <sub>G(AV)</sub>	Average gate power dissipation		1	W
P <sub>GM</sub>	Peak gate power dissipation	t <sub>p</sub> = 20 μs	10	W
I <sub>GM</sub>	Peak gate current	t <sub>p</sub> = 20 μs	4	Α
V <sub>GM</sub>	Peak positive gate voltage	t <sub>p</sub> = 20 μs	16	V

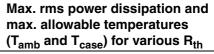
 Table 4.
 Gate characteristics (maximum values)

#### Table 5.Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>th(j-a)</sub>	Junction to ambient	60	°C/W
R <sub>th(j-c)</sub> DC	Junction to case for DC	2.5	°C/W
R <sub>th(j-c)</sub> AC	Junction to case for 360 °Conduction angle (F = 50 Hz)	1.9	°C/W

#### Figure 1. Max. rms power dissipation versus Figure 2. on-state rms current (F = 50Hz). (curves limited by (dl/dt)c)





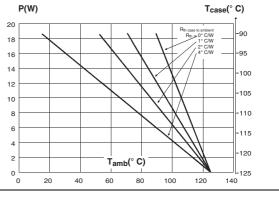


Figure 3. On-state rms current versus case temperature

Relative variation of thermal impedance versus pulse duration

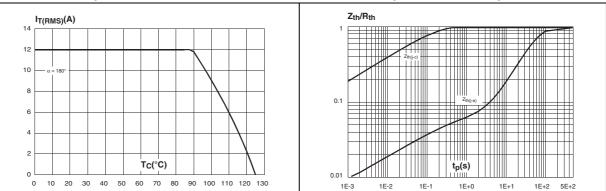
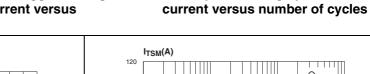


Figure 4.



#### Figure 5. Relative variation of gate trigger Figure 6. current and holding current versus junction temperature



100

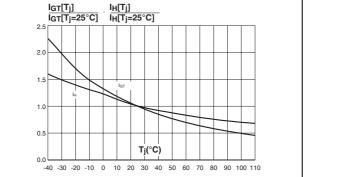
80

60

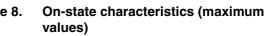
40

20

0 0



# Figure 7. Non-repetitive surge peak on-state Figure 8. current for a sinusoidal pulse and corresponding values of I<sup>2</sup>t



111

100

1000

Number of cycles

10

Non repetitive surge peak on-state

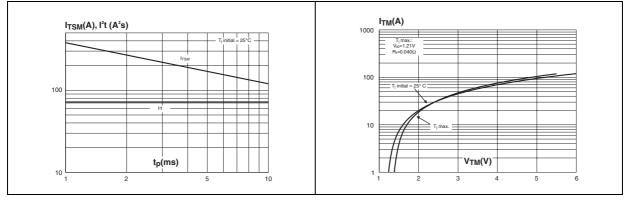
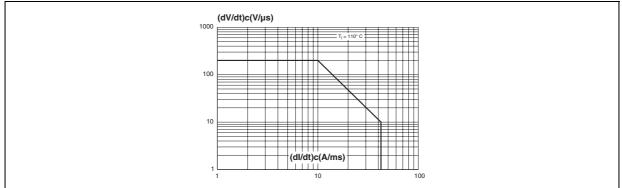


Figure 9. Safe turn-off operating area





## 2 Package information

- Epoxy meets UL94,V0
- Cooling method: C (by conduction)
- Recommended torque value: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK<sup>®</sup> is an ST trademark.

Table 6. TO-220AB insulated dimensions

					Dimer	nsions		
		Ref.	Mi	illimete	rs		Inches	
			Min.	Тур.	Max.	Min.	Тур.	Max.
		А	15.20		15.90	0.598		0.625
		a1		3.75			0.147	
B		a2	13.00		14.00	0.511		0.551
	b2,	В	10.00		10.40	0.393		0.409
	F C2 M	b1	0.61		0.88	0.024		0.034
A		b2	1.23		1.32	0.048		0.051
I4 I3 -∰-		С	4.40		4.60	0.173		0.181
		c1	0.49		0.70	0.019		0.027
		c2	2.40		2.72	0.094		0.107
a2		е	2.40		2.70	0.094		0.106
		F	6.20		6.60	0.244		0.259
e b1	⊸ c1	ØI	3.75		3.85	0.147		0.151
		14	15.80	16.40	16.80	0.622	0.646	0.661
		L	2.65		2.95	0.104		0.116
		12	1.14		1.70	0.044		0.066
		13	1.14		1.70	0.044		0.066
		М		2.60			0.102	

## **3** Ordering information

#### Table 7.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
TXDV812RG	TXDV812	TO-220AB	2.3 g	50	Tube
TXDV1212RG	TXDV1212	insulated	2.5 y	50	Tube

# 4 Revision history

#### Table 8.Document revision history

Date	Revision	Changes
30-Mar-2011	1	Initial release.
13-Jan-2012	2	Updated dl/dt in Table 2, and added $V_{to}$ and $R_d$ in Table 3



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